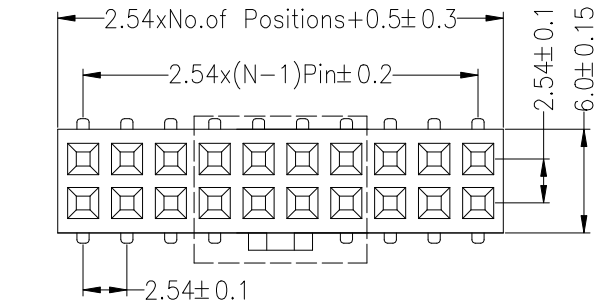
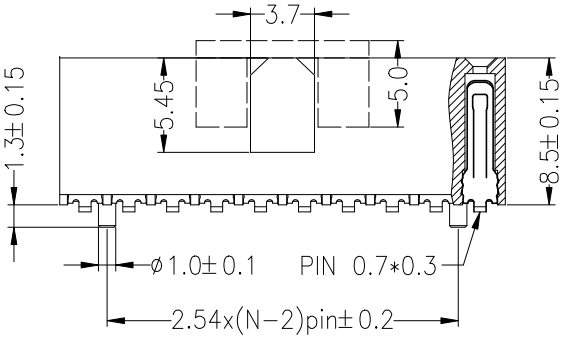
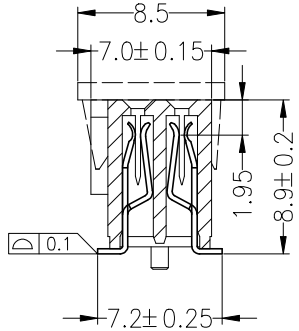
HSF RoHS

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:550V AC/Minute
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: LCP
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



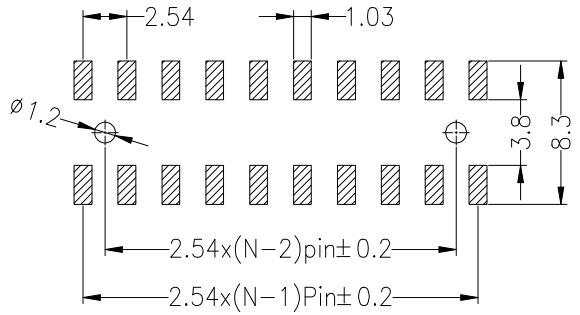




## Ordering Information

**2285 02 XX X W XX M D X 0X**

- 02: No.of Pins Per Row 3−40
- X: Insulator Material Option — F=BK−LCP
- W: Post — W=With Post
- XX: Contact Plating — G1:Gold Flash; G3:2U" Gold; G4:3U" Gold; G5:5U" Gold; S0:Gold Flash/Tin; S1:3U" Gold/Tin; SN:Tin
- D: Packing — A=Tray; T=Tube; R=Reel




Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

| REV | DATE | MODIFICATION DESCRIPTION | CHANGE |
|---|---|---|---|
| A0 | 2022.04.01 | NEW DRAWING | |

| OPERATION | | DRAW | Liu Miao | 22.04.01 | SCALE | FIT |
|---|---|---|---|---|---|---|
| X.X | ±0.30 | | | | UNIT | mm |
| X.XX | ±0.20 | CHECK | | | SIZE | A4 |
| X.XXX | ±0.10 | | | | SHEET | 1/1 |
| Angle | ±3° | APPROVE | | | PROJ. | |
| DIM | TOL | | | | | |

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

| PART NO. | 228502XXXWXXMDX0X |
|---|---|
| TITLE: | 2.54PF H8.5mm 2xNpin SMT 欧式端子 |